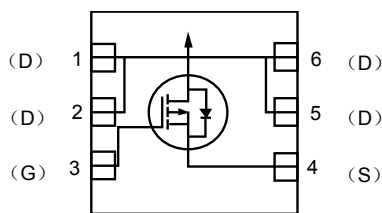


## Description

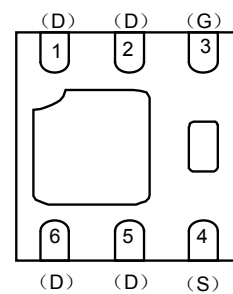
The enhancement mode MOS is extremely high density cell and low on-resistance.

MOSFET Product Summary		
$V_{DS}(V)$	$R_{DS(on)}(m\Omega)$	$I_D(A)$
-20	14 @ $V_{GS}=-4.5V$	-10

Internal structure



Bottom View



## Absolute maximum rating@25°C

Rating		Symbol	Value	Units
Drain-Source Voltage		$V_{DS}$	-20	V
Gate-Source Voltage		$V_{GS}$	$\pm 12$	V
Drain Current	Continuous $T_A=25^\circ C$	$I_D$	-10	A
	Pulsed $T_A=70^\circ C$	$I_D$	-40	A
Total Power Dissipation	$T_A=25^\circ C$	$P_D$	2.4	W
	$T_A=125^\circ C$	$P_D$	0.9	W
Operating and Storage Junction Temperature Range		$T_J, T_{STG}$	-55 to +150	$^\circ C$

## Thermal Characteristics

Parameter	Symbol	Max.	Units
Thermal Resistance, Junction to Ambient (Note 1a)	$R_{\theta JA}$	52	$^\circ C/W$
Thermal Resistance, Junction to Ambient (Note 1b)	$R_{\theta JA}$	145	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	6.9	

## Electrical characteristics per line @25°C ( unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D = -250\mu A, V_{GS} = 0V$	-20	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -16V, V_{GS} = 0V$	-	-	-1.0	$\mu A$
Gate-to-Source Forward Leakage	$I_{GSS}$	$V_{GS} = \pm 10V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.5	-0.9	-1.5	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -4.5V, I_D = -10A$	-	14	17	m $\Omega$
		$V_{GS} = -2.5V, I_D = -8A,$	-	18	25	m $\Omega$
		$V_{GS} = -1.8V, I_D = -3A,$	-	26	50	m $\Omega$
Forward Trans conductance	$g_{FS}$	$V_{DS} = -5V, I_D = -10A$	-	45	-	S
Total Gate Charge	$Q_g$	$I_D = -10A, V_{DD} = -6V,$ $V_{GS} = -4.5V$	-	37	45	nC
Gate-to-Source Charge	$Q_{gs}$		-	6.5		
Gate-to-Drain(Miller) Charge	$Q_{gd}$		-	2.5		
Input Capacitance	$C_{ISS}$	$V_{GS} = 0V, V_{DS} = -15V,$ $f = 1MHz$	-	4540		pF
Output Capacitance	$C_{DSS}$		-	1100		pF
Reverse Transfer Capacitance	$C_{RSS}$		-	810		pF
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6.0V, I_D = -10A,$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega,$	-	40	60	ns
Rise Time	$t_r$		-	40	60	
Turn-Off Delay Time	$t_{d(off)}$		-	170	270	
Fall Time	$t_f$		-	90	150	
Source to Drain Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_S = -2A$		-0.6	-1.2	V
		$V_{GS} = 0V, I_S = -10A$		-0.8	-1.2	

Typical Characteristics

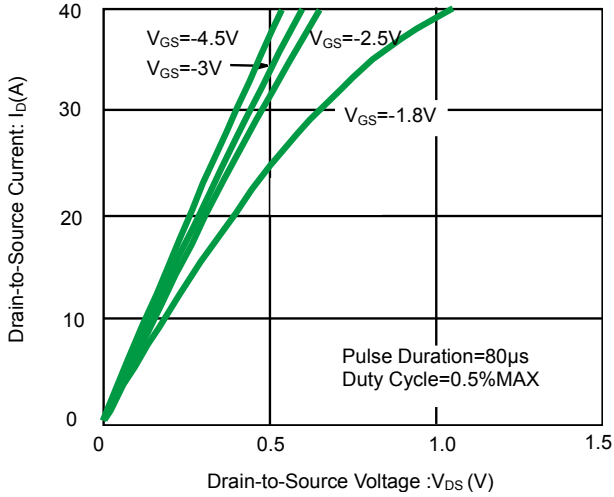


Fig 1. On-Region Characteristics

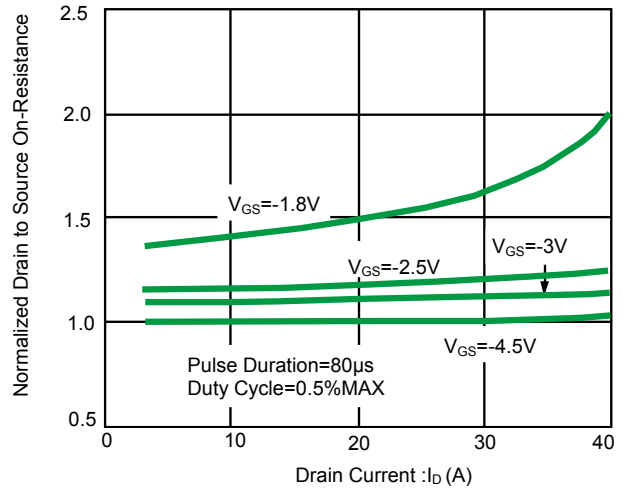


Fig 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

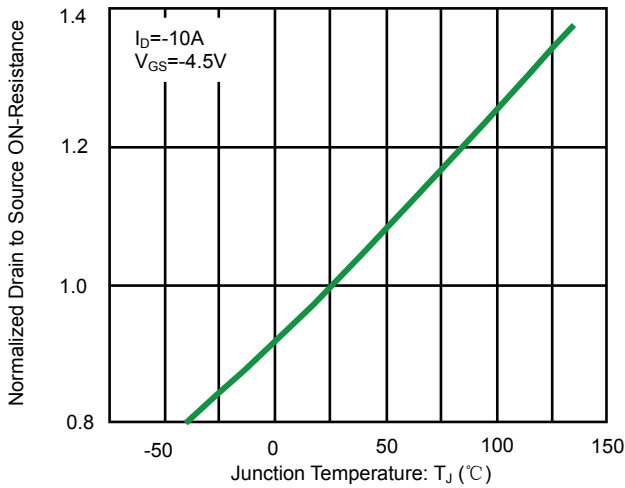


Fig 3. Normalized On-Resistance vs. Junction Temperature

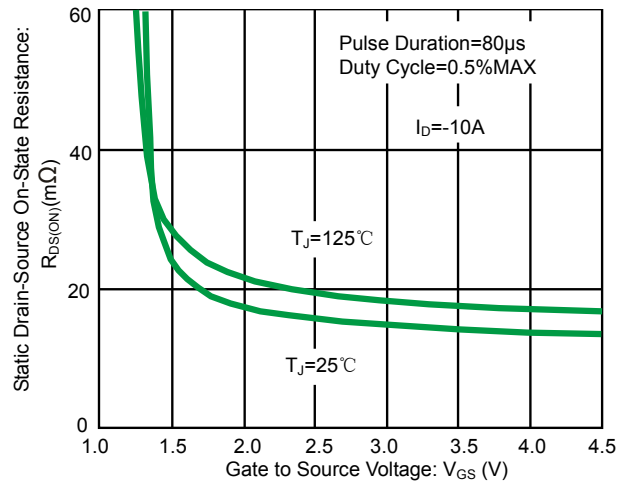


Fig 4. On-Resistance vs. Gate to Source Voltage

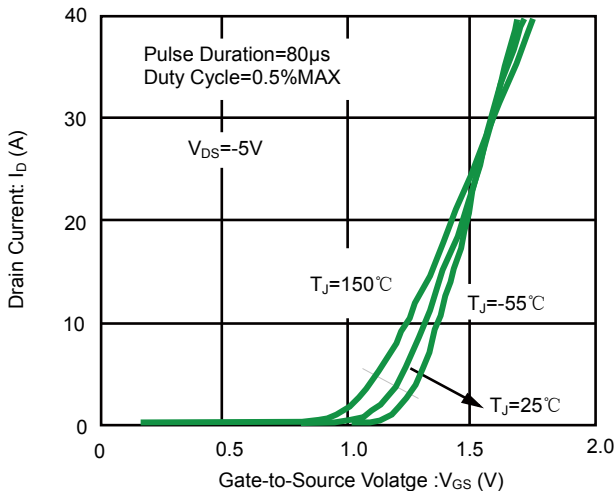


Fig 5. Transfer Characteristics

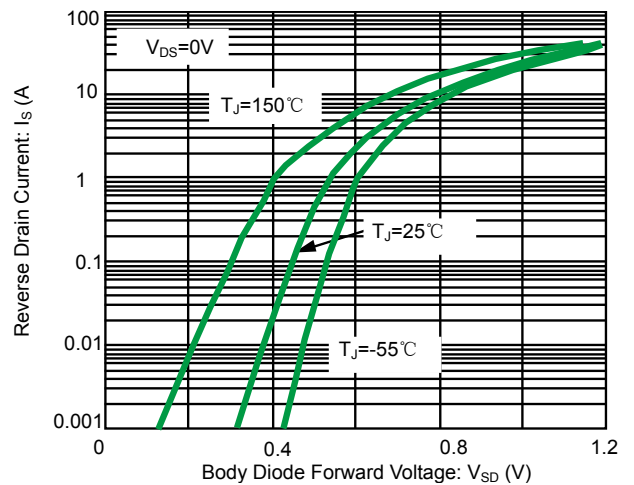


Fig 6. Source to Drain Diode Forward Voltage vs. Source Current

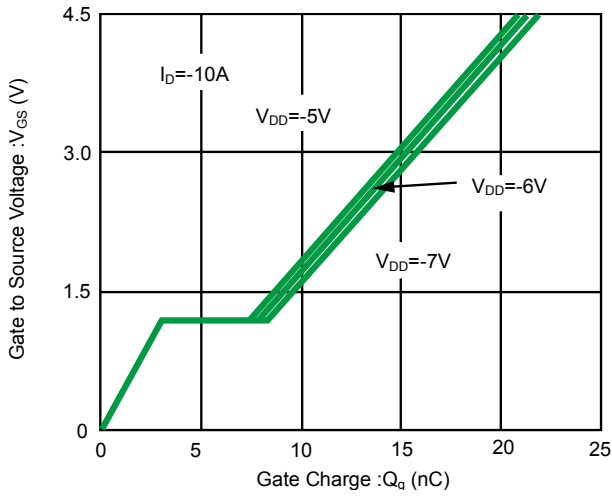


Fig 7. Gate Charge Characteristics

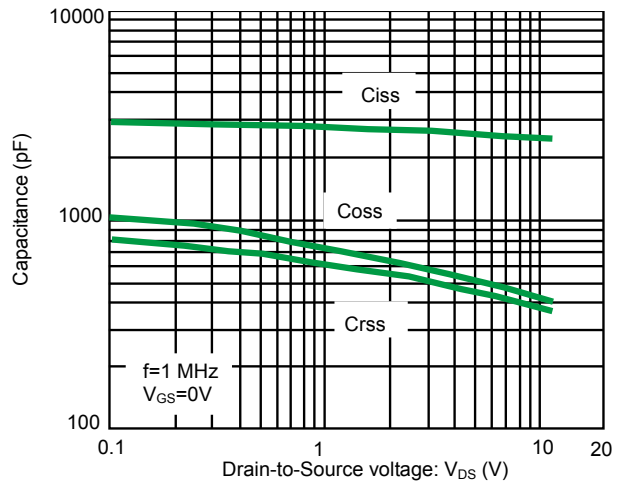


Fig 8. Capacitance vs. Drain to Source Voltage

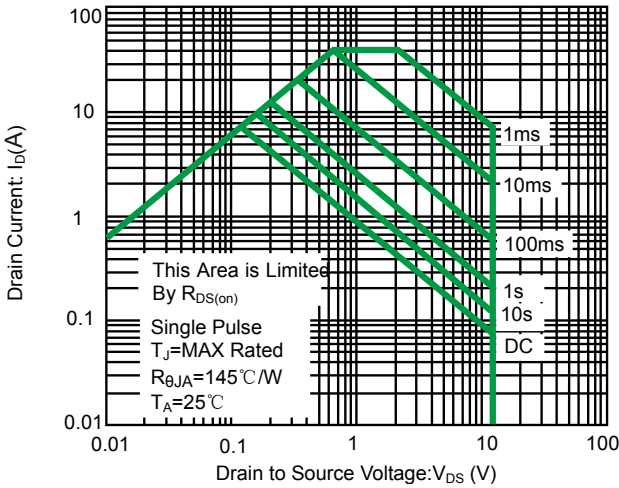


Fig 9. Forward Bias Safe Operating Area

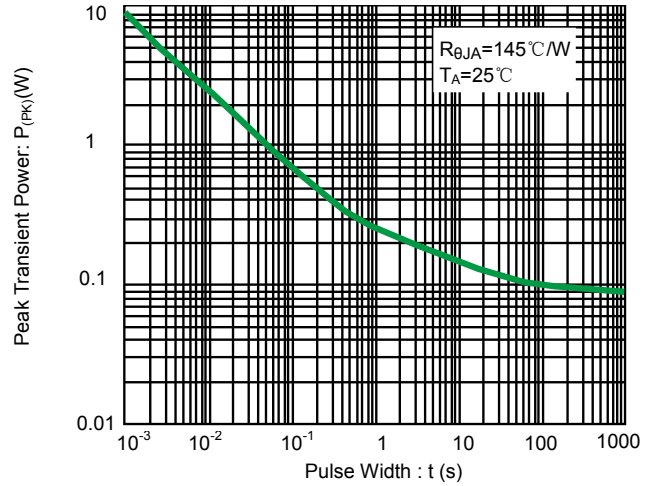


Fig 10. Single Pulse Maximum Power Dissipation

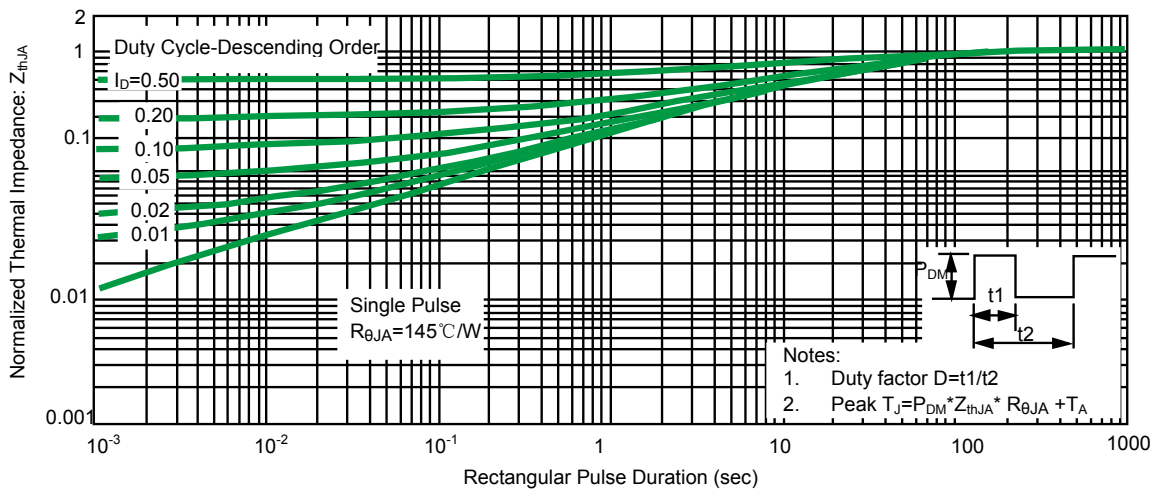
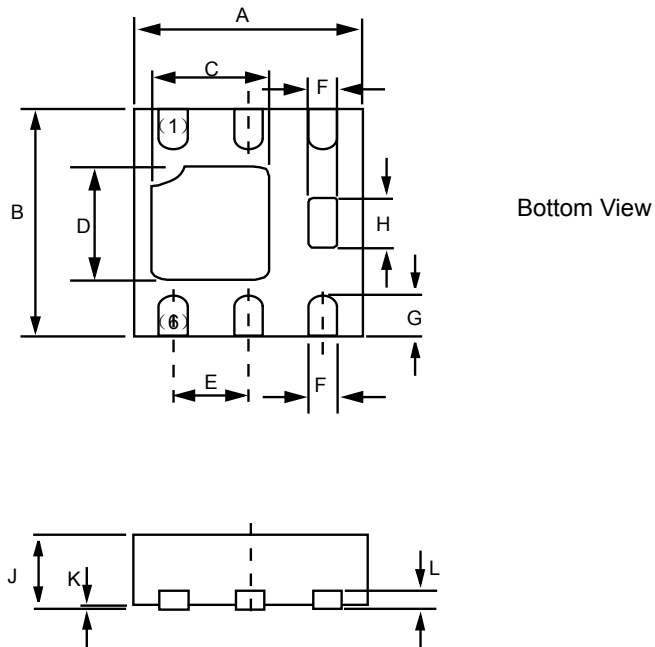


Fig 11. Transient Thermal Response Curve, Junction-to-Ambient


Product dimension (DFN2\*2-6L)

DFN2\*2-6L



Dim	Millimeters		Inches	
	MIN	MAX	MIN	MAX
A	1.95	2.05	0.077	0.081
B	1.95	2.05	0.077	0.081
C	0.85	0.95	0.033	0.037
D	0.75	0.85	0.029	0.033
E	0.65 BSC.		0.026 BSC.	
F	0.25	0.35	0.009	0.014
G	0.30	0.40	0.012	0.016
H	0.51	0.61	0.020	0.024
J	0.70	0.80	0.027	0.031
K	0.00	0.05	0.000	0.002
L	0.203 Ref.		0.008 Ref.	


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